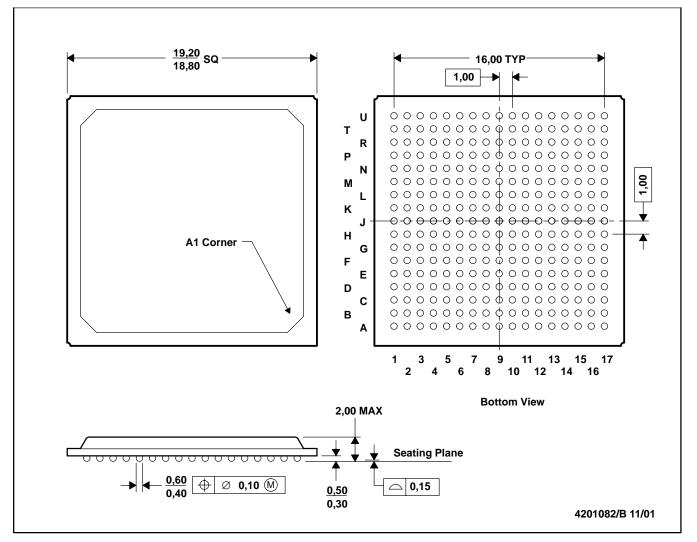
MECHANICAL DATA

MPBG140A - JUNE 2000 - REVISED FEBRUARY 2002

GNT (S-PBGA-N289)

PLASTIC BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. B. This drawing is subject to change without notice.



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